

Adopting Party Name
3eYamaichi Electronics Co., Ltd.
Aces Electronics Co., Ltd.
ACES Electronics Co., Ltd.
Action Star Enterprise Co., Ltd.
Advanced-Connectek Inc., Acon
Agilent Technologies Inc.
ALLTOP TECHNOLOGY CO., LTD.
Amco Tec International Inc.
American Megatrends, Inc.
Amphenol Assemble Tech (Xiamen) Co., Ltd.
Amphenol ShouhMin Industry (Shenzhen) Co., Ltd.
Argosy Research Inc.
Astron International Corp.
Basler AG
Bose Corporation
Buffalo Inc.
Buffalo Kokuyo Supply Inc.
Cambridge Silicon Radio Limited
Canon Inc.
Chant Sincere Co., Ltd.
Cheng Uei Precision Industry Co., Ltd.
Chicony Electronics Co., Ltd.
Chief Land Electronic Co., Ltd.
China Electronics Technology Limited
Chrontel, Inc.
Circuit Assembly Corp.
CNPLUS Co., Ltd.
Compupack Technology Co. Ltd.
Connect County Holdings Berhad
DataFab Systems Inc.
Digital Design Corporation
Digital Information Technology Studies (ShenZhen) Ltd.
DisplayLink (UK) Ltd
DongGuan HYX Industrial Co., Ltd.
Dongguan Kechenda Electronics Technology Co., Ltd.
Dongguan Teconn Electronics Technology Co., Ltd.
Dongguan Yuqin Electronics Co., Ltd.
EchoStar Technologies, LLC
Elektrobit, Inc.
FCI USA LLC
Foosung Tech

Foxconn Interconnect Technology, Ltd ("FIT LTD")
Freeport Resources Enterprises Corp.
Fujitsu Limited
Full in Hope Co., Ltd.
Global Connector Technology Ltd. (GCT)
Global Unichip Corp.
Goodway Technology Co., Ltd.
Harris Corporation
Hewlett Packard
High-Top Precision Electronic Co., Ltd.
Hirose Electric Co., Ltd.
Hosiden Corporation
Hsi Chin Electronics Co., Ltd.
IBM Corporation
ICT-Lanto Limited
I-PEX USA LLC
Integral Memory PLC
Intel Corporation
Japan Aviation Electronics Industry, Limited
Jmicron Technology Corporation
Jo-Dan International
Joinsoon Electronic Mfg. Co., Ltd.
JPC/Main Super Inc
J.S.T. Mfg. Co., Ltd.
JVC KENWOOD Holdings, Inc.
Kawasaki Microelectronics, Inc.
Kycon, Inc.
KYOCERA MITA Corporation
Lenjoy Technology Limited
Littelfuse Inc.
Lotes Co., Ltd.
LS Mtron Ltd.
LucidPort Technology, Inc.
Luxshare-ICT, Inc.
Main Super Enterprises Co., Ltd.
Marvell International Ltd.
Master Hill Electric Wire & Cable Co., Ltd.
Medialogic Corp.
Microchip
Microsoft Corporation
Mitsumi Electric Co., Ltd.
Morning Star Digital Connector Co. Ltd.
NEC Corporation
NXP B.V.

Octekconn Incorporation
Oculus VR, LLC
P-Two Industries Inc.
Panasonic Corporation
PERFECTUS TECHNOLOGY, INC.
Philips & Lite-On Digital Solutions Corp.
Phison Electronics Corp.
Plastoform Industries Ltd.
Protop International Inc.
RATOC Systems, Inc.
Renesas Electronics Corporation
Ricoh Imaging Company, Ltd.
Scosche Industries, Inc.
SHEN MING ELECTRON (DONG GUAN) CO., LTD.
Shenzhen Deren Electronic Co., Ltd.
Shenzhen DNS Industries Co., Ltd
Shenzhen Linkconn Electronics Co., Ltd.
Shenzhen Pang Ngai Industrial Co., Ltd.
Shenzhen Tronixin Electronics Co., Ltd.
Sierra Wireless, Inc.
Silicon Interfaces
Singatron Enterprise Co., Ltd.
SMK Corporation
Socionext Inc.
Spectra7 Microsystems
Speedtech Corp.
Standard Microsystems Corporation ("SMSC")
ST-Ericsson
STMicroelectronics
ST-NXP Wireless
Sunwoda Electronic Co. Ltd.
Suyin Corporation
Sweetray Industrial Ltd.
T-Conn Precision Corporation
Tai Twun Enterprise Co., Ltd.
Taiwan Semiconductor Manufacturing Company, Ltd.
Telecommunications Technology Association
Texas Instruments
THine Electronics, Inc.
Tsay-e (BVI) International Inc.
Tyco Electronics
U D Electronic Corp
Unixtar Technology Inc.
VAIO Corporation

Valve Corporation
VIA Alliance Semiconductor Co., Ltd.
VIA Technologies, Inc.
Volex (Asia) Pte. Ltd.
Wieson Technologies Co., Ltd.
Win Win Precision Ind., Co., Ltd.
Xiaomi Communications Co., Ltd.
Y-S Electronic Co., Ltd.
Zen Factory Group (Asia) Limited
Zhejiang Fousine Science & Technology Co., Ltd.
Zoom Corporation